

Top View

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Vishay Siliconix

N-Channel 20 V (D-S) Fast Switching MOSFET

Bottom View

PRODUCT SUMMARY						
V _{DS} (V)	20					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 10 \text{ V}$	0.0053					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 4.5 \text{ V}$	0.0078					
Q _g typ. (nC)	14					
I _D (A)	21.1					
Configuration	Single					

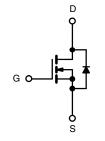
FEATURES

- TrenchFET® Gen II power MOSFET
- PWM optimized
- 100 % R_q tested
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912



APPLICATIONS

- Synchronous rectification
- · Synchronous buck



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK 1212-8
Lead (Pb)-free and halogen-free	SiSH110DN-T1-GE3

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless		SYMBOL	10 s	STEADY	UNIT	
Drain-source voltage	V _{DS}	20	STATE 20			
Gate-source voltage		V _{GS}	± 20	± 20	V	
Continuous dusin august /T 150 90\3	T _A = 25 °C	- I _D	21.1	13.5		
Continuous drain current (T _J = 150 °C) ^a	T _A = 70 °C		16.9	10.8		
Pulsed drain current		I _{DM}	60	60	А	
Continuous source current (diode conduction) a		I _S	3.2	1.3		
Single avalanche current		I _{AS}	35	35		
Single avalanche energy	L = 0 1 mH	E _{AS}	61	61	mJ	
Maximum navvar discination 3	T _A = 25 °C	Б	3.8	1.5	14/	
Maximum power dissipation ^a	T _A = 70 °C	P _D	2	0.8	W	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150		°C	
Soldering recommendations (peak temperature) b, c			260			

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient ^a	t ≤ 10 s	В	24	33	
Waximum junction-to-ambient -	Steady state	R _{thJA}	65	81	°C/W
Maximum junction-to-case (drain)	Steady state	R_{thJC}	1.9	2.4	

Notes

- a. Surface mounted on 1" x 1" FR4 board
- b. See solder profile (www.vishay.com/doc?73257). The PowerPAK 1212-8SH is a leadless package within the PowerPAK 1212-8 package family. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components



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SPECIFICATIONS (T _J = 25 °C	C, unless oth	nerwise noted)				
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Gate threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	1.5	-	2.5	V
Gate-body leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
Zero gate voltage drain current	la a a	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$ -		-	1	
zero gate voltage drain current	I _{DSS}	V_{DS} = 20 V, V_{GS} = 0 V, T_J = 55 °C	-	-	5	μΑ
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 5 V$, $V_{GS} = 10 V$	40	-	-	Α
Drain acurae en etete registance A	В	$V_{GS} = 10 \text{ V}, I_D = 21.1 \text{ A}$	-	0.0044	0.0053	Ω
Drain-source on-state resistance ^a Forward transconductance ^a Diode forward voltage ^a Dynamic ^b Total gate charge Gate-source charge	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 17.4 \text{ A}$	-	0.0064	0.0078	7.2
Forward transconductance a	9 _{fs}	V _{DS} = 15 V, I _D = 21.1 A	-	71	-	S
Diode forward voltage ^a	V _{SD}	I _S = 3.2 A, V _{GS} = 0 V	-	0.8	1.2	V
Dynamic ^b						
Total gate charge	Q_g		-	14	21	nC
Gate-source charge	Q_{gs}	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 21.1 \text{ A}$	-	7	-	
Gate-drain charge	Q_{gd}		-	4.5	-	
Gate resistance	R_g	f = 1 MHz	0.7	1.4	2.1	Ω
Turn-on delay time	t _{d(on)}		-	12	20	
Rise time	t _r	V_{DD} = 10 V, R_L = 10 Ω	-	10	15	
Turn-off delay time	t _{d(off)}	$I_D \cong 1$ A, $V_{GEN} = 10$ V, $R_g = 6$ Ω	=	36	55	ns
Fall time	t _f		-	10	15	
Body diode reverse recovery time	t _{rr}		-	30	60	
Body diode reverse recovery charge	Q _{rr}	$I_F = 3.2 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s}$	-	25	50	nC
Reverse recovery fall time	ta	$_{1F} = 3.2 \text{ A}, \text{ u/u} = 100 \text{ A/} \mu \text{s}$	-	14	-	no
Reverse recovery rise time	t _b		-	16	-	ns

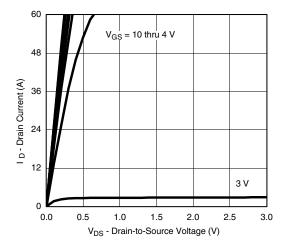
Notes

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing

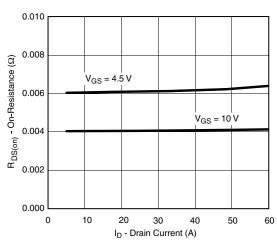
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



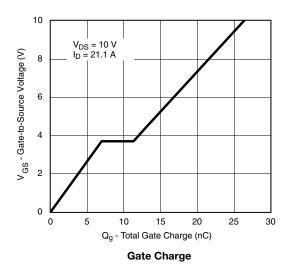
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Output Characteristics

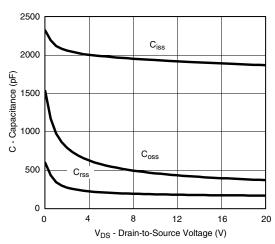


On-Resistance vs. Drain Current

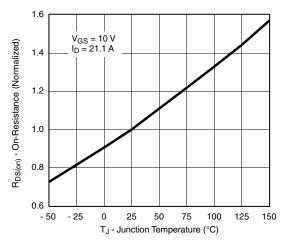


60 48 I_D - Drain Current (A) 36 24 T_C = 125 °C 12 55 °C 0.5 2.0 0.0 1.0 1.5 2.5 3.0 3.5 4.0 V_{GS} - Gate-to-Source Voltage (V)

Transfer Characteristics



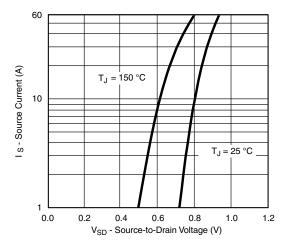
Capacitance



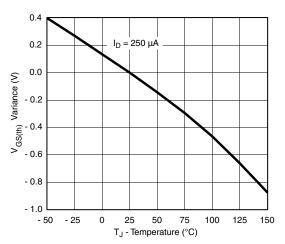
On-Resistance vs. Junction Temperature



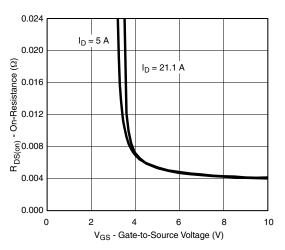
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



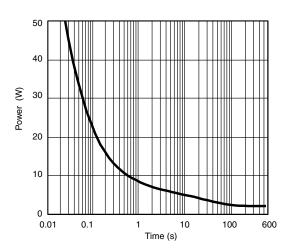
Source-Drain Diode Forward Voltage



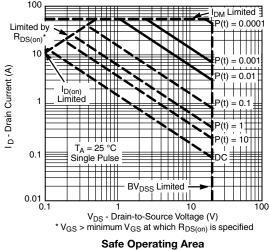
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage

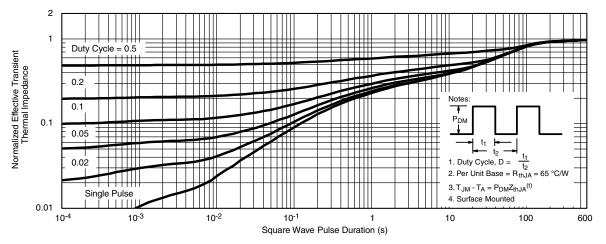


Single Pulse Power, Junction-to-Ambient

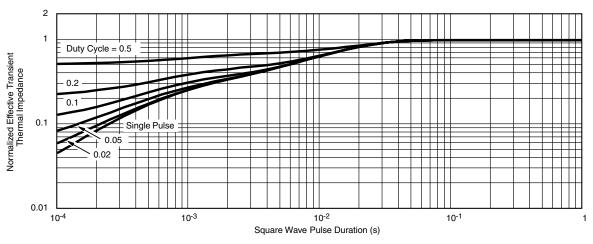




TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

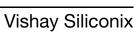


Normalized Thermal Transient Impedance, Junction-to-Ambient



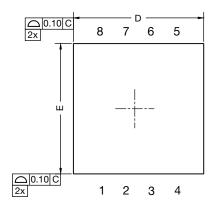
Normalized Thermal Transient Impedance, Junction-to-Case

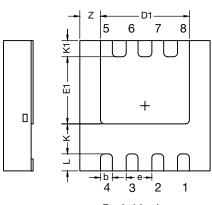
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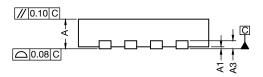


PowerPAK® 1212-SWLH





Backside view



DIM	MILLIMETERS			INCHES				
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		
Α	0.82	0.90	0.98	0.032	0.035	0.038		
A1	0	-	0.05	0	-	0.002		
A3	0.20 ref.			0.008 ref.				
b	0.30 BSC			0.012 BSC				
D	3.30 BSC			0.130 BSC				
D1	2.15	2.25	2.35	0.084	0.088	0.092		
E	3.30 BSC			0.130 BSC				
E1	1.60	1.70	1.80	0.063	0.067	0.071		
е	0.65 BSC			0.026 BSC				
K		0.76 typ.			0.030 typ.			
K1	0.41 typ.			0.41 typ. 0.016 typ.				
L	0.43 BSC				0.017 BSC			
Z	0.525 typ. 0.021 typ.							

DWG: 6062



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